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**Auto-Torque Implementation Reference Design**

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**Design Features**

- Reduces Energy Consumption of a Stepper Motor by 66%
- Avoids Stalling at Variable Loads and at Variable Speeds
- Offers Simple Control

**Design Resources**

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**Featured Applications**

- Robotics
- Printers
- Stage Lighting
- Security Cameras
- Medical
- Industrial Machines

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Design Overview

This TI Design uses a TI stepper motor driver booster pack and ultralow-power MSP microcontroller LaunchPad™ to demonstrate the implementation of a new stepper motor control strategy. TI intends this strategy to reduce energy consumption and prevent stalling of a stepper motor.

2 System Description

The setup consists of the TI DRV8711 BoosterPack™ that forms the power stage for the stepper motor and the MSP430G2 LaunchPad, which performs the desired control functions. The stepper motor connects to the BoosterPack and implements dynamic torque control is implemented through the DRV8711 and MSP430.

2.1 DRV8711 BoosterPack

Boost-DRV8711 is a stepper motor BoosterPack based on the DRV8711 stepper motor controller and CSD88537ND Dual 60-V N-Channel NexFET™ Power MOSFETs. This BoosterPack provides a complete stepper motor drive stage to evaluate motor applications. See Figure 1 for more details.

- Offers a complete stepper motor drive stage in a small form factor (1.75 inch × 2.00 inch)
- Supports 8.2 V to 52 V and up to 4.5 A continuous for each H-bridge
- Offers 4× CSD88537ND Dual (8 FETs) 60-V N-Channel NexFET Power MOSFETs (12.5 mΩ)
- Offers motor stall and device fault LED indicators
- Offers a fully protected drive stage including overcurrent, overtemperature, undervoltage, and motor stall detect
- Can be combined with TI LaunchPad kits to create a complete stepper motor drive and control platform

For further details, see the DRV8711 Stepper Motor Controller IC datasheet (SLVSC40E), the CSD88537ND datasheet (SLPS455A), and the BOOST-DRV8711 User's Guide (SLVU967).
2.2 **MSP430G2 LaunchPad**

The MSP-EXP430G2 LaunchPad is an inexpensive and simple evaluation kit for the MSP430G2xx Value Line series of microcontrollers. The LaunchPad features an integrated DIP target socket that supports up to 20 pins, allowing MSP430™ Value Line devices to be plugged into the LaunchPad board. The MSP-EXP430G2 LaunchPad comes with an MSP430G2553 device by default. The MSP430G2553 has the most memory available of the compatible value line devices. The MSP430G2553 16-bit MCU has 16-KB flash, 512 bytes of RAM, a CPU speed up to 16-MHz, 10-bit ADC, capacitive touch enabled I/Os, universal serial communication interface, and more. See Figure 2 for more details.

![MSP430G2 LaunchPad](image)

**Figure 2. MSP430G2 LaunchPad**

**Features**

- Offers a USB debugging and programming interface featuring a driverless installation and application UART serial communication with up to 9600 baud
- Supports MSP430G2xx2, MSP430G2xx3, and MSP430F20xx devices in PDIP14 or PDIP20 packages
- Offers two general-purpose digital I/O pins connected to green and red LEDs for visual feedback
- Offers a two-push button for user feedback and device reset
- Offers easily accessible device pins for debugging purposes or as a socket for adding customized extension boards
- Offers a high-quality 20-pin DIP socket for an easy plug-in or removal of the target device


2.3 **Stepper Motor**

A stepper motor is an electromechanical device which converts electrical power into mechanical power. The motor is a brushless, synchronous electric motor that can divide a full rotation into an expansive number of steps. The position of the motor can be controlled accurately without any feedback mechanism, as long as the motor is carefully sized to the application. Stepper motors are similar to switched reluctance motors. Any application that uses a catalog stepper motor subjected to variable load is likely to benefit from this control strategy.
4 Highlighted Products

4.1 DRV8711 Driver IC

The DRV8711 device is a stepper motor that uses external N-channel MOSFETs to drive a driver bipolar stepper motor or two brushed DC motors. A microstepping indexer is integrated and capable of step modes from full step up to 1/256-step. An ultrasmooth motion profile can be achieved using adaptive blanking time and various current decay modes, including an auto-mixed decay mode. Motor stall is reported with an optional BEMF output. A simple STEP/DIR or PWM interface allows easy interfacing to controller circuits. An SPI serial interface programs the device operation. Output current (torque), step mode, decay mode, and stall detection functions are all programmable through the SPI serial interface.

4.2 MSP430G2553 Microcontroller

MSP430G2553 is a ultralow-power mixed signal microcontroller with built-in 16-bit timers, up to 24-I/O capacitive-touch enabled pins, a versatile analog comparator, and built-in communication capability using the universal serial communication interface. In addition, the microcontroller has a 10-bit analog-to-digital converter (ADC). Using the digitally-controlled oscillator (DCO), the MSP430G2553 can wake up from low-power modes in less than 1 µs.

4.3 CSD88537ND Power MOSFET

The CSD88537ND is a Dual SO-8, 60-V, 12.5-mΩ N-Channel NexFET power MOSFET designed to serve as a half bridge in low-current motor control applications.

5 System Design Theory

When connected to a variable load, a stepper motor must be configured to drive the maximum possible torque to prevent motor stall conditions. This continuous maximum torque is driven even when the motor load is very small, which leads to a high-power dissipation. Missing a few steps might be unacceptable in certain position control applications like robotics, medical equipment, and other end equipment. In these applications, the output current must be set at a constant maximum value to prevent missed steps. Alternatively, a closed-loop control can be implemented to adjust the output current automatically to prevent step loss and stall. The feedback signal for this control can be anything related to position, speed, or torque, which can be obtained by adding sensors such as hall sensors, encoders, and so forth. Adding sensors is counterproductive as stepper motors are used primarily because they provide easy, sensorless position control.

When measured, back emf (BEMF) of the motor is an indication of the rotational speed of the motor. When the motor gets loaded down, the speed of the motor is momentarily reduced. This reduction can be captured using the BEMF signal and missed steps or stall conditions can be prevented if the stepper motor current is increased. DRV8711 stepper motor is capable of sampling the BEMF of the stepper motor during operation and provides an analog voltage output for the BEMF. This BEMF can be a feedback signal to close the loop and incorporate the torque control.
5.1 Control Strategy

After making the hardware changes in the DRV8711 BoosterPack and MSP430G2 LaunchPad, a PI controller implements the control algorithm. The potentiometer on the BoosterPack is used to command the speed of the motor.

5.2 Working Algorithm

The BEMF waveform is read into the ADC, which is averaged over several cycles to smooth the waveform. When the analog value is obtained, the current motor speed is determined from a programmed look-up table. The reference speed from the potentiometer is used to set the operation state of the motor. If the reference speed is too low, the motor halts. If the reference speed is very low, the motor spins but the control is omitted because the BEMF waveform may be unpredictable or have a signal that is too small. When the motor speed is acceptable, the torque control activates and the PI controller manipulates the stepper motor current based on the measured speed error. Speed error has been relaxed to certain extent to avoid rapid fluctuation in the torque which translates to current fluctuation (this fluctuation translates to noise). The following describes the algorithm flow:

- ADC obtains the digital value of the potentiometer reading which is used to obtain the reference speed of the motor from the look-up table.
- Based on the reference speed, the motor spins under full control, spins without control, or stops.
- ADC obtains the digital value of the BEMF reading, which is used to obtain the present speed of the motor from the look-up table. Speed error is calculated from reference and present speeds of the motor.
- Depending on the range of speed error, average the BEMF readings to eliminate any unwanted transient behavior.
- When Integral function is performed as part of PI control, the integral variable is obtained. The PI controller output is directly manipulated to reduce the output torque if the motor load is constant or decreasing. Choose the range to avoid stalling.
- The final output of the PI controller is again modified to accommodate extreme conditions.
- The MSP430 writes to the DRV8711 TORQUE register through a SPI transaction to set the chopping current and change the output current in the stepper motor.
Figure 3 shows the algorithm:

Figure 3. Flow Chart
5.3 PI Controller Tuning

The PI controller plays a key role in increasing the torque level when the motor is suddenly loaded. Because the algorithm is based on the principle that present speed of the motor can never exceed the reference speed, the PI controller is unable reduce the torque level of the motor. An additional control is placed on top of the PI controller to reduce the torque level periodically and settle down at the minimum required torque level. This control ensures maximally efficient operation. The values of Kp and Ki are pivotal in transient and steady state performances of the motor. While the value of Kp increases the response speed, the value of Ki determines the steady state error of the system.

Do not increase the value of Kp too much as this increases the time for the motor current transition from loaded to unloaded condition, which wastes power. Increasing Ki value reduces the transition period, which might cause the motor to stall at certain speeds. Choose an optimum value to satisfy the previously mentioned recommendations.

6 Getting Started

6.1 Motor Characterization

The relationship between (BEMF) and speed forms the heart of the algorithm because this is how motor load changes are determined. For any motor, BEMF and speed are directly proportional and their relation can be obtained by using the following procedure:

1. Plug the stepper motor BoosterPack onto the LaunchPad as shown in Figure 4.
   (a) Align the TXD and RXD jumpers on the MSP-EXP430G2 Pad horizontally (the black rectangle in Figure 4) to operate the hardware UART with a software application.
   (b) Solder a wire to the BEMF pin (pin 20) of the DRV8711 driver IC (yellow rectangle shown in Figure 4) and another to pin 2 that corresponds to nSTALL pin (blue rectangle shown in Figure 4) of jumper J2 on the BoosterPack.
   (c) Connect the outputs of BEMF and nSTALL to the oscilloscope.

![Figure 4. BoosterPack and MSP430G2 LaunchPad](image)
2. Connect your stepper motor to the terminal block header J5. (The motor should have two windings, each with a + and a − termination.)
   (a) Connect one winding to A1/A2.
   (b) Connect the other winding to B1/B2. (See DRV8711 Stepper Motor Controller IC datasheet [SLVSC40E] for further details.)

3. Connect the power supply that powers the DRV8711 of the stepper motor BoosterPack and drive stage to the terminal block header J6.

   **NOTE:** The connections have been labeled VM and GND. The stepper motor BoosterPack has an operating range from 8.2 V to 52 V up to 4.5 A continuous for each H-bridge. When using the MSPEXP430G2 LaunchPad and an MSP430G2553, BOOST-DRV8711 GUI controls the motor. To get started with the GUI, see sections 4.3 and 4.4 of the BOOST-DRV8711 User's Guide (SLVU967).

4. Use the following settings for motor characterization using the BOOSTXL-DRV8711 GUI.

<table>
<thead>
<tr>
<th>Setting Names</th>
<th>Recommended Values</th>
</tr>
</thead>
<tbody>
<tr>
<td>EXSTALL</td>
<td>Turned on</td>
</tr>
<tr>
<td>MODE</td>
<td>1/4 /Half-Step</td>
</tr>
<tr>
<td>ISGAIN</td>
<td>20</td>
</tr>
<tr>
<td>SMPLTH</td>
<td>300 µs</td>
</tr>
<tr>
<td>VDIV</td>
<td>Divided by 32/16/8/4</td>
</tr>
<tr>
<td>Target Speed (PPS)</td>
<td>(RPM × 40) ÷ 3 – Quad step-or-(RPM × 20) ÷ 3 – Half step</td>
</tr>
</tbody>
</table>

5. Connect the outputs of BEMF and nSTALL to the oscilloscope.

   **NOTE:** By changing the Target Speed (PPS), the speed of the motor can be changed. Perform the following steps.

6. Gradually increase the target speed to find the maximum speed at which the motor can rotate.
7. Note this maximum speed as Speed_max.
8. For speeds less than this Speed_max, measure the BEMF pin and nSTALL pins on the EVM board to get the BEMF characteristics.

   **NOTE:** The DRV8711 begins sampling BEMF data when there is a low-to-high transition in the nSTALL pin. The voltage on the BEMF pin of the DRV8711 is high immediately after a low-to-high transition and the beginning of the DRV8711 sampling. After the motor phase current has decreased to zero, the BEMF sample is stable. This BEMF sample can be read by the microcontroller on a high-to-low transition from the STALL pin. The BEMF can be recorded then the nSTALL pin transitions from high to low. The BEMF and nSTALL pins operate as shown in Figure 5 and Figure 6.

Large motors may exhibit an unstable BEMF at lower speeds. This lower speed, less than which the BEMF waveforms are unredictable, is considered as Speed_min.
9. Slowly change the speed from zero to Speed_max.
10. Observe the BEMF waveform. (If the BEMF value goes higher than 2.5 V, change the DRV8711 to a higher VDIV setting.)

**NOTE:**
The BEMF waveform can lose its periodicity at higher speeds (less than maximum speed). An unstable BEMF at high speed can be easily identified through the fact that the BEMF waveform lacks a step pulse. Find the maximum speed where the BEMF waveform is periodic and unsaturated. Consider this value the new Speed_max.

The BEMF vs speed (rpm) data can be obtained at different speeds less than Speed_max to use in the header file look-up table.

![Figure 5. Several Periods of nSTALL and BEMF](image)

![Figure 6. One nSTALL Event](image)
6.2 Modifying Hardware

The BEMF pin in the DRV8711 BoosterPack is not routed to the MSP430G2 LaunchPad by default. The BEMF pin must be routed to an MSP430 pin with an available ADC peripheral. The pinout diagram omit show that pins p1.1 and p1.2 of header J1 are reserved for UART communication and also have ADC as one of the peripherals. Because UART is unneeded for this application, one of these pins can be used to read the BEMF presented by the DRV8711 on the BEMF pin. A small wire is used to tie the BEMF pin to p1.1 of the MSP430.

![Figure 7. Modified BoosterPack and MSP430G2 LaunchPad](image)

In the MSP-EXP430G2 LaunchPad, the jumper connections pertaining to UART connection must be disconnected to be able to use the pins p1.1 and p1.2. Figure 7 shows the location of jumpers on the launch pad (in yellow rectangles). The jumper corresponding to the LED should also be used, which indicates when the motor is not operated under control (in black rectangles in Figure 7).

7 Getting Started Firmware

The MSP430™ firmware is provided. This code was developed and modified in Code Composer Studio™ (CCS).

7.1 Header File Changes

Open the header file in CCS and make the following changes.

- **Look-up table for speed variation from potentiometer:**
  1. Calibrate the potentiometer to 258 rpm.
  2. Set breakpoints to monitor the present speed.
  3. Note the maximum speed of the motor.
  4. Recalibrate the potentiometer for the maximum value.

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**NOTE:** This increases the scaling of the speed and is optional.

Reference Speed = \([\text{Speed}_{\text{max}} \times \text{(ADC output)}] \div 31\)

The excel sheet includes the formula for this conversion.
5. Modify the header file lookup-table for Speed_functn[].

- **Look-up table for timer count variation:**
  - Based on the look-up table for speed variation from potentiometer, obtain the look-up table for timer count by applying the following formula in the excel sheet:
    \[
    \text{timer count} = \frac{1000000 \times 60}{(\text{reference speed} \times \text{step size} \times 200)}
    \]

- **Look-up table for speed from BEMF:** When the BEMF vs speed data is obtained using either of the previously mentioned methods, do the following.
  1. Prepare a look up table to include the motor characteristics for the algorithm.
  2. Enter 128 discrete values relating the BEMF ADC measurement to speed.

  **NOTE:** The digital values corresponding to the BEMF values are directly used to point at the speed of the motor in the look-up table.

  3. Enter the next highest speed at which to operate the Automatic Torque control.
  4. Enter the maximum speed value into the values next to the maximum speed

  **NOTE:** The excel sheet provides instructions to get the digital values of BEMF readings.

- **Speed details:** The following includes details on speed min, speed max_NC, speed max, and torque min values.
  - The motor remains at rest if the speed is less than Speed min.
  - The algorithm is disabled if the motor speed is less than max_NC. Select max_NC based on the BEMF waveform consistency at low-speed operation. Motors with low inductance and high-current ratings have poor torque handling capabilities at lower speeds.

- **Control parameters:** Kp and Ki values of the PI controller might require tuning according the performance of the motor after the control implementation. There is a trade off between transient performance and steady state performance. To obtain optimum values, use trial and error.
7.2 Main Setup

The following steps explain how to program the hardware.

1. Download the Auto-Torque Implementation software project from the software section.
2. Open the project in the CCS (see Figure 8).
3. Make the changes in the header file if necessary (variable_lib.h).
4. Debug the project to run the motor.

![Figure 8. Screenshot of CCS With Auto-Torque Implementation Project Loaded](image-url)
8 Test Setup

The testing setup consists of the DRV8711 BoosterPack with MSP430 LaunchPad, stepper motor, torque sensor, and dynamometer. See Figure 9.

The specifications of the motor tested are as follows:

- Step angle: 1.8 degrees
- Rated Current: 1.4 A

Figure 9. BoosterPack + LaunchPad, Stepper Motor, Torque Sensor, and Dynamometer
9 Test Data

9.1 Current Waveforms at 140 rpm

Figure 10. Phase Current at Full Load of 34N-cm

Figure 11. Phase Current at Load of 29N-cm
Figure 12. Phase Current at a Load of 21N-cm

Figure 13. Phase Current at No Load
9.2 Current Waveforms at Extreme Conditions

Figure 14. Current at Maximum Speed of 258 rpm and Full Load of 34N-cm

Figure 15. Current at 80 rpm When Motor is Not in Control
9.3 **Current Transition From One Load State to Another Load State**

![Graph](image1)

**Figure 16. Current Transition From Full Load of 34N-cm to No Load at Maximum Speed**

![Graph](image2)

**Figure 17. Current Transition From Full Load to Load of 21N-cm at Max Speed**
9.4 Energy Consumption

The energy consumed by the motor is measured using at different speeds and at different loads with and without Auto-Torque control. There is a significant reduction in energy consumption, especially at lower loads. Figure 19 shows an increase in the energy consumption at 225 rpm when the motor is in control because of an observed inconsistency in the BEMF waveform.
10 Software Files

To download the software files for this reference design, see the link at http://www.ti.com/tool/TIDA-00740.

11 References

1. TI WEBENCH Design Center, http://www.ti.com/webench
2. TI E2E Community, http://e2e.ti.com/
3. DRV8711 Stepper Motor Controller IC datasheet (SLVSC40E)
4. CSD88537ND Datasheet (SLPS455A)
5. BOOST-DRV8711 User's Guide (SLVU967)
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